Layer 0 Upgrade Detector

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Introduction

- HPS is planning on upgrading the existing SVT by adding another tracking layer between the target and current 1st layer
- This should drastically improve our vertexing reach
- Tracking layers 2 and 3 are also being moved towards the beam for increased long-lived A' acceptance
- Reach comparison for the first layer hit requirements as well as other relevant simulations are presented
- Increased backgrounds studies due to upgrade are also presented

L0 Upgrade Simulation Dimensions

- Layer 0 sensor will contain 256 channels per sensor (no intermediate strip), an axial and stereo sensor on top/bottom and positron/electron side. Each sensor is 10 x 14.08 mm and strips are 200 microns in simulation (aiming for 150 microns)
- Nominal has 640 readout channels (with intermediate strip), an axial stereo sensor on top/bottom and positron/electron side for layers 4-6. Each sensor is 100 x 38.4 mm and strips are 250 microns



L0 Monte Carlo

- A lot of computing time spent on L0 MC (thanks Brad), lots of troubleshooting, and still a few issues to be solved
- tritrig-wab-beam wabs with beam background combined with tridents with beam background at enhanced rate
 - Normalized by trident rate 155 ¹/_{nb} (about 13% of 2015 total luminosity at 0.5 mm) for both nominal and L0 (direct comparison)
 - wabs are NOT enhanced, so these are underestimated.
 Eventually will have the correct proportions
 - Skeptical of this normalization (probably about 75% luminosity over-estimate) based on rates compared to tritrig + wab and wab-beam-tri and data
 - Goal is to obtain total 2015 luminosity at 0.5 mm
 - Used to fit vertex tails to compute zcut, rate is used for reach plots

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L0 Monte Carlo (cont.)

- Pure wabs, radiatives, and tridents (tritrig)
 - Used to compute radiative fraction $\left(\frac{radiatives}{wabs+tridents}\right)$
 - MG5 radiatives for L0 are on the way
- wab-beam-tri closest MC we have to beam
 - 30 s of beam for L0; 10 s of beam for nominal
 - Used for backround studies trigger rates, occupancies, wab conversion rates, and beam background rates
- Prompt and displaced A's
 - Used for acceptance and efficiency studies and mass resolution

L0 Studies

- Acceptance (prompt A's)
- Invariant Mass (Displaced A's)
- Displaced Efficiency $\frac{A's \ Detectable \ after \ cuts}{A' \ truth}$ (Displaced A's)
- Vertex Tail Fitting and Z Cuts
- Reach Plots for First Layer Hit Requirements
- ▶ Future Plans for Reach Plots Using Other Layer Requirements
- Backgrounds
 - Increased converted wabs due to L0 and moving L2/L3
 - Occupancies (in the near future)
- Detailed plots here: L0 Plots

Acceptance

- Geometrical acceptance for prompt A's as a function of mass for 1.05 GeV, 2.3 GeV, and 4.4 GeV beam energies
- The comparison is 5 hits in the nominal detector compared to 6 hits in L0 detector





Cuts

- Analysis divided into mutually exclusive layer requirement categories
 - Nominal total reach = L1L1 + L1L2 + L2L2
 - Upgrade total reach = L0L0 + L0L1 + L1L1 + L1L2 + L2L2 + L0L2
- L0 Track $\chi^2 < 35$ and shared hits must be less than 4

 Current cuts eliminate about 20% more A' and background in L0

Trigger type	"pairs-1" trigger
Track-cluster matching (position)	$\chi^2_{match} < 10$
Track-cluster matching (time)	$ t_{cl} - t_{trk} - 43 < 4 \text{ ns}$
Cluster time coincidence	$ t_{cl}(e^{-}) - t_{cl}(e^{+}) < 2 \text{ ns}$
Top-bottom requirement	$sign(y_{cl}(e^{-})) \neq sign(y_{cl}(e^{+}))$
Elastics cut	$p(e^{-}) < 0.75 E_{beam}$
Momentum sum cut	$p_{tot}(e^+e^-) < 1.15E_{beam}$
Radiative cut	$p_{tot}(e^+e^-) > 0.8E_{beam}$
Layer 1 requirement	layer 1 hits for both tracks
Track quality	$\chi^{2}_{trk} < 30$
Beamspot constraint	$\chi^2_{bsc} < 10, \ \chi^2_{bsc} - \chi^2_{unc} < 5$
Layer 1 isolation	see text
Momentum asymmetry	$ p(e^{-}) - p(e^{+}) /(p(e^{-}) + p(e^{+})) < 0.4$
Positron DOCA	$d_0(e^+) < 1.5 \text{ mm}$

Mass Vertex Resolution Improvement

Displaced A' mass resolution for unconstrained V0s



Long-lived A' Efficiency Improvement

- Moving in L2 and L3 improves efficiency for long-lived A's (only visible in L1L2 and L2L2 layer requirements)



Long-lived A' Efficiency Improvement (cont.)

Total efficiency sums efficiency of exclusive layer requirements



Vertex Resolution Improvement

 Vertex resolution improves by about a factor of 2 for 1.05 GeV(dependent on mass and beam energy)



Vertex Resolution Improvement All Energies

- Background are dominated by multiple scattering which decreases with increasing momentum
- L0 vertex resolution improvement decreases slightly with increasing beam energy (still a very good improvement!)



Improved Z Cuts

- Improved vertex resolution causes improved z cuts (by about the same factor)
- Z cuts for L0 (left) and nominal (right) at various luminosities



Effect of Improved Z Cut

- A' decays are exponential in z, so the number of detectable A's increases dramatically for lower Z Cut
- Efficiency after cuts and acceptance with z cuts (left), produced A's (right)



Procedure for Obtaining Reach - Determining Z Cuts

- Fit function B(z) to tritrig distribution after cuts (Gaussian with non-Gaussian tail)
- Scale function for desired luminosity, z cut is where
 B(z) = 0.5 events in a mass bin of 2.6 times mass resolution

$$B(z;\bar{z},\sigma,b,l) = \begin{cases} e^{-\frac{(z-\bar{z})^2}{2\sigma^2}} & \text{if } z \leq \bar{z}+b, \\ e^{-\frac{b^2}{2\sigma^2} - (z-\bar{z}-b)/l} & \text{if } z \geq \bar{z}+b \end{cases}$$



Procedure for Obtaining Reach - Calculating Detectable A's

$$\mu s(z) = (N_{A'} \epsilon_{reco}(z_{targ})) \frac{e^{\frac{z_{targ} - z}{\gamma c\tau}}}{\gamma c\tau} \frac{\epsilon_{reco}(z)}{\epsilon_{reco}(z_{targ})} \epsilon_{cut}(z)$$
(1)

- Number of detectable events is simply ∫^{zmax}_{z_{cut} μs(z)dz} (essentially efficiency(z) * acceptance(z) * number of A's(z))
- Reach contours are defined at the 90% confidence level which is 2.3 expected events



Reach Plot L0L0/L1L1 Comparison

- The procedure of requiring hits in the first layer is well understood (thanks to Sho and Holly)
- Reach plots compare L0L0 in ugrade detector vs L1L1 in the nominal detector (for a direct comparison we need L0L0 + L0L1 + L1L1 for upgrade detector, so we are underestimating our reach)



Reach Plot L0L0/L1L1 Comparison (cont.)



L0 Upgrade

Number A's Detectable L0L0/L1L1

 Number of detectable A's past all cuts comparing L0L0 for L0 and L1L1 for nominal at 180 days



Difficulty With Other Layer Requirements

- Backgrounds due to hit inefficiencies are cut out by extrapolating track to active sensor (inefficiencies are NOT present in MC)
- Remaining background is due to a hard scatter in the dead silicon into the acceptance of the rest of the tracker



Difficulty With Other Layer Requirements (cont.)

- Shifts peak of the distribution towards larger z
- Curves show the fraction of efficiency curve (i.e. the 10% curve is the $z_{0.10}$ is the solution to $\frac{\int_{z_{targ}}^{z_{0.10}} eff(z)dz}{\int_{z_{rarg}}^{z_{max}} eff(z)dz} = 0.10$)
- Higher mass has larger z efficiency curves (may not even need zcut)



Other Layer Requirements Vz vs. Mass Nominal

- Can we trust this MC? Does this agree with data?
- In data, L1L2 has 30,000 events and L2L2 has 250 events at 120 1/nb (compared to 155 1/nb in MC)
- In the near future, add the correct proportion of wabs and tighten up track extrapolation cut



Other Layer Requirements Vz vs. Mass Upgrade Detector



Backgrounds

- Backgrounds produced at the target remain the same in upgrade detector
- Increased multiple scattering due to silicon (L0) in tracker which is accounted for in the previous analysis
- Increased converted wabs due to extra silicon (L0) and moving silicon into lower angular acceptance (L2 and L3)
- Trigger rate is 30 kHz for L0 and 22 kHz for nominal



Backgrounds - Increased Wabs due to L0

- ► Only beamspot \(\chi_2\) (for bad track fits) and isolation cuts (for mis-hits) are present
- There is clearly a large rate increase at L0 due to converted wabs
- The remainder of vertexing cuts eliminates these events



Backgrounds - Increased Wabs due to L2 and L3

- Large rate increase for electrons below 15 mrad (due to L2 and L3 moving towards the beam)
- Requiring opposite volumes of electrons/positrons minimizes this rate increase





Future Work

- Mix correct fraction of wabs into the MC and solve other MC issues
- More carefully optimize cuts for L0, currently cutting out too many events (also solve other minor problems)
- Obtain total reach from all exclusive layer requirements (very challenging)
 - Vertex pulls and impact parameter cuts seem promising
- Recoil electron acceptance studies and occupancy studies
- Do it all again for 2.3 GeV!
- Open for ideas (but not too open...)

Conclusion

- Adding a tracking layer between the target and current first layer improves vertex resolution by about a factor of 2 in all relevant beam energies, and hence improves the zcut
- By simply requiring first layer hits, the L0 detector shows a drastic improvement in reach compared to the current setup for 1.05 GeV
- It is reasonable to say that reach will improve significantly for other relevant beam energies
- Moving in tracking layers 2 and 3 in by 0.8 mm improves displaced A' detection acceptance
- Mass resolution also improves slightly, and background rates are manageable
- It is recommended that L0 production proceed ASAP (Tim)

Backup Slides

MC Rate Comparisons



Backup Slides

Vertex Z for background simulation using vertexing cuts





 Number of A's detectable for 4 weeks for L0 (left) and nominal (right)





 Number of A's detectable for 10 weeks for L0 (left) and nominal (right)





 Number of A's detectable for 180 days for L0 (left) and nominal (right)

